MC14541B

Programmable Timer

The MC14541B programmable timer consists of a 16–stage binary counter, an integrated oscillator for use with an external capacitor and two resistors, an automatic power–on reset circuit, and output control logic.

Timing is initialized by turning on power, whereupon the power–on reset is enabled and initializes the counter, within the specified V_{DD} range. With the power already on, an external reset pulse can be applied. Upon release of the initial reset command, the oscillator will oscillate with a frequency determined by the external RC network. The 16–stage counter divides the oscillator frequency (f_{osc}) with the nth stage frequency being $f_{osc}/2^n$.

- Available Outputs 2^8, 2^{10}, 2^{13} or 2^{16}
- Increments on Positive Edge Clock Transitions
- Built–in Low Power RC Oscillator ($\pm 2\%$ accuracy over temperature range and $\pm 20\%$ supply and $\pm 3\%$ over processing at < 10 kHz)
- Oscillator May Be Bypassed if External Clock Is Available (Apply external clock to Pin 3)
- External Master Reset Totally Independent of Automatic Reset Operation
- Operates as 2^n Frequency Divider or Single Transition Timer
- Q/$\overline{Q}$ Select Provides Output Logic Level Flexibility
- Reset (auto or master) Disables Oscillator During Resetting to Provide No Active Power Dissipation
- Clock Conditioning Circuit Permits Operation with Very Slow Clock Rise and Fall Times
- Automatic Reset Initializes All Counters On Power Up
- Supply Voltage Range = 3.0 Vdc to 18 Vdc with Auto Reset Disabled (Pin 5 = V_{DD})
  = 8.5 Vdc to 18 Vdc with Auto Reset Enabled (Pin 5 = V_{SS})

MAXIMUM RATINGS (Voltages Referenced to V_{SS}) (Note 2.)

Symbol	Parameter	Value	Unit
V_{DD}	DC Supply Voltage Range	-0.5 to $+18.0$	V
V_{in}, V_{out}	Input or Output Voltage Range (DC or Transient)	-0.5 to $V_{DD} + 0.5$	V
I_{in}	Input Current (DC or Transient)	± 10 (per Pin)	mA
I_{out}	Output Current (DC or Transient)	± 45 (per Pin)	mA
P_D	Power Dissipation, per Package (Note 3.)	500	mW
T_A	Ambient Temperature Range	-55 to $+125$	°C
T_{stg}	Storage Temperature Range	-65 to $+150$	°C
T_L	Lead Temperature (8–Second Soldering)	260	°C

2. Maximum Ratings are those values beyond which damage to the device may occur.
3. Temperature Derating:
   Plastic "P and D/DW" Packages: -7.0 mW/°C From 65°C To 125°C

ON Semiconductor

MARKING DIAGRAMS

PDIP–14
P SUFFIX
CASE 646

```
14
MC14541BCP
AWLYYWW
1
```

SOIC–14
D SUFFIX
CASE 751A

```
14
14541B
AWLYWW
1
```

TSSOP–14
DT SUFFIX
CASE 948G

```
14
14
541B
ALYW
1
```

SOEIAJ–14
F SUFFIX
CASE 965

```
14
MC14541B
AWLYWW
1
```

A = Assembly Location
WL or L = Wafer Lot
YY or Y = Year
WW or W = Work Week

ORDERING INFORMATION

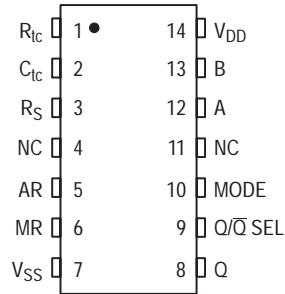| Device	Package	Shipping
MC14541BCP	PDIP–14	2000/Box
MC14541BD	SOIC–14	55/Rail
MC14541BDR2	SOIC–14	2500/Tape & Reel
MC14541BDT	TSSOP–14	96/Rail
MC14541BDTR2	TSSOP–14	2500/Tape & Reel
MC14541BF	SOEIAJ–14	See Note 1.
MC14541BFEL	SOEIAJ–14	See Note 1.

1. For ordering information on the EIAJ version of the SOIC packages, please contact your local ON Semiconductor representative.

This device contains protection circuitry to guard against damage due to high static voltages or electric fields. However, precautions must be taken to avoid applications of any voltage higher than maximum rated voltages to this high–impedance circuit. For proper operation, V_{in} and V_{out} should be constrained to the range $V_{SS} \le$ (V_{in} or V_{out}) $\le V_{DD}$.

Unused inputs must always be tied to an appropriate logic voltage level (e.g., either V_{SS} or V_{DD}). Unused outputs must be left open.

MC14541B

PIN ASSIGNMENT

```
        _____
R_tc [  1 •    14  ] V_DD
C_tc [  2     13  ] B
R_S  [  3     12  ] A
NC   [  4     11  ] NC
AR   [  5     10  ] MODE
MR   [  6      9  ] Q/Q̄ SEL
V_SS [  7      8  ] Q
        ‾‾‾‾‾‾‾‾‾‾‾
```

NC = NO CONNECTION

ELECTRICAL CHARACTERISTICS (Voltages Referenced to V_{SS})

Characteristic	Symbol	V_{DD} Vdc	−55°C Min	−55°C Max	25°C Min	25°C Typ [4]	25°C Max	125°C Min	125°C Max	Unit
Output Voltage "0" Level $V_{in} = V_{DD}$ or 0	V_{OL}	5.0	—	0.05	—	0	0.05	—	0.05	Vdc
		10	—	0.05	—	0	0.05	—	0.05	
		15	—	0.05	—	0	0.05	—	0.05	
"1" Level $V_{in} = 0$ or V_{DD}	V_{OH}	5.0	4.95	—	4.95	5.0	—	4.95	—	Vdc
		10	9.95	—	9.95	10	—	9.95	—	
		15	14.95	—	14.95	15	—	14.95	—	
Input Voltage "0" Level (V_O = 4.5 or 0.5 Vdc) (V_O = 9.0 or 1.0 Vdc) (V_O = 13.5 or 1.5 Vdc)	V_{IL}	5.0	—	1.5	—	2.25	1.5	—	1.5	Vdc
		10	—	3.0	—	4.50	3.0	—	3.0	
		15	—	4.0	—	6.75	4.0	—	4.0	
"1" Level (V_O = 0.5 or 4.5 Vdc) (V_O = 1.0 or 9.0 Vdc) (V_O = 1.5 or 13.5 Vdc)	V_{IH}	5.0	3.5	—	3.5	2.75	—	3.5	—	Vdc
		10	7.0	—	7.0	5.50	—	7.0	—	
		15	11	—	11	8.25	—	11	—	
Output Drive Current (V_{OH} = 2.5 Vdc) Source (V_{OH} = 9.5 Vdc) (V_{OH} = 13.5 Vdc)	I_{OH}	5.0	−7.96	—	−6.42	−12.83	—	−4.49	—	mAdc
		10	−4.19	—	−3.38	−6.75	—	−2.37	—	
		15	−16.3	—	−13.2	−26.33	—	−9.24	—	
(V_{OL} = 0.4 Vdc) Sink (V_{OL} = 0.5 Vdc) (V_{OL} = 1.5 Vdc)	I_{OL}	5.0	1.93	—	1.56	3.12	—	1.09	—	mAdc
		10	4.96	—	4.0	8.0	—	2.8	—	
		15	19.3	—	15.6	31.2	—	10.9	—	
Input Current	I_{in}	15	—	±0.1	—	±0.00001	±0.1	—	±1.0	µAdc
Input Capacitance (V_{in} = 0)	C_{in}	—	—	—	—	5.0	7.5	—	—	pF
Quiescent Current (Pin 5 is High) Auto Reset Disabled	I_{DD}	5.0	—	5.0	—	0.005	5.0	—	150	µAdc
		10	—	10	—	0.010	10	—	300	
		15	—	20	—	0.015	20	—	600	
Auto Reset Quiescent Current (Pin 5 is low)	I_{DDR}	10	—	250	—	30	250	—	1500	µAdc
		15	—	500	—	82	500	—	2000	
Supply Current [5] [6] (Dynamic plus Quiescent)	I_D	5.0	$I_D = (0.4\ \mu A/kHz)\,f + I_{DD}$							µAdc
		10	$I_D = (0.8\ \mu A/kHz)\,f + I_{DD}$							
		15	$I_D = (1.2\ \mu A/kHz)\,f + I_{DD}$							

4. Data labelled "Typ" is not to be used for design purposes but is intended as an indication of the IC's potential performance.
5. The formulas given are for the typical characteristics only at 25°C.
6. When using the on chip oscillator the total supply current (in µAdc) becomes: $I_T = I_D + 2\,C_{tc}\,V_{DD}\,f \times 10^{-3}$ where I_D is in µA, C_{tc} is in pF, V_{DD} in Volts DC, and f in kHz. (see Fig. 3) Dissipation during power−on with automatic reset enabled is typically 50 µA @ V_{DD} = 10 Vdc.

MC14541B

SWITCHING CHARACTERISTICS [7.] (C_L = 50 pF, T_A = 25°C)

Characteristic	Symbol	V_{DD}	Min	Typ [8.]	Max	Unit
Output Rise and Fall Time t_{TLH}, t_{THL} = (1.5 ns/pF) C_L + 25 ns t_{TLH}, t_{THL} = (0.75 ns/pF) C_L + 12.5 ns t_{TLH}, t_{THL} = (0.55 ns/pF) C_L + 9.5 ns	t_{TLH}, t_{THL}	5.0 10 15	— — —	100 50 40	200 100 80	ns
Propagation Delay, Clock to Q (2^8 Output) t_{PLH}, t_{PHL} = (1.7 ns/pF) C_L + 3415 ns t_{PLH}, t_{PHL} = (0.66 ns/pF) C_L + 1217 ns t_{PLH}, t_{PHL} = (0.5 ns/pF) C_L + 875 ns	t_{PLH} t_{PHL}	5.0 10 15	— — —	3.5 1.25 0.9	10.5 3.8 2.9	µs
Propagation Delay, Clock to Q (2^{16} Output) t_{PHL}, t_{PLH} = (1.7 ns/pF) C_L + 5915 ns t_{PHL}, t_{PLH} = (0.66 ns/pF) C_L + 3467 ns t_{PHL}, t_{PLH} = (0.5 ns/pF) C_L + 2475 ns	t_{PHL} t_{PLH}	5.0 10 15	— — —	6.0 3.5 2.5	18 10 7.5	µs
Clock Pulse Width	$t_{WH(cl)}$	5.0 10 15	900 300 225	300 100 85	— — —	ns
Clock Pulse Frequency (50% Duty Cycle)	f_{cl}	5.0 10 15	— — —	1.5 4.0 6.0	0.75 2.0 3.0	MHz
MR Pulse Width	$t_{WH(R)}$	5.0 10 15	900 300 225	300 100 85	— — —	ns
Master Reset Removal Time	t_{rem}	5.0 10 15	420 200 200	210 100 100	— — —	ns

7. The formulas given are for the typical characteristics only at 25°C.
8. Data labelled "Typ" is not to be used for design purposes but is intended as an indication of the IC's potential performance.

(R$_{tc}$ AND C$_{tc}$ OUTPUTS ARE LEFT OPEN)
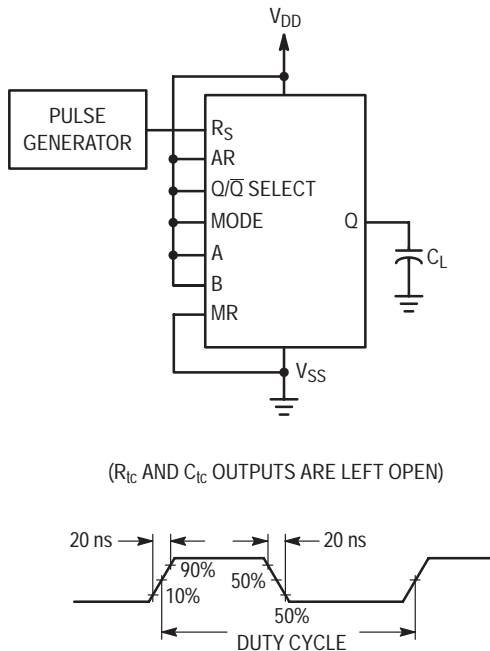
Figure 1. Power Dissipation Test Circuit and Waveform
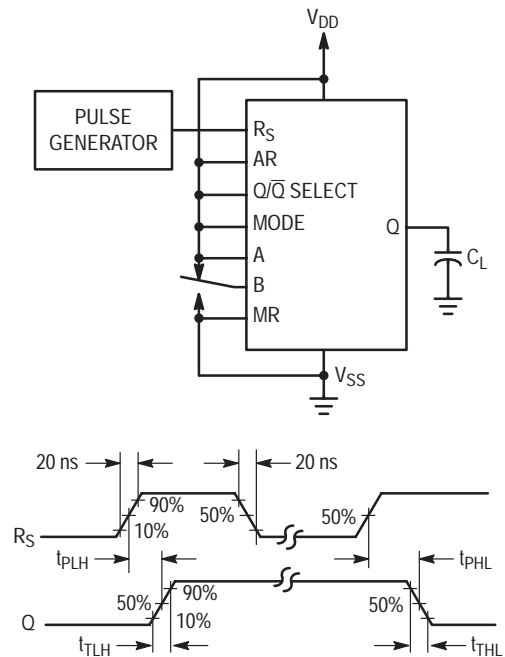
Figure 2. Switching Time Test Circuit and Waveforms

MC14541B

EXPANDED BLOCK DIAGRAM

V_DD = PIN 14
V_SS = PIN 7
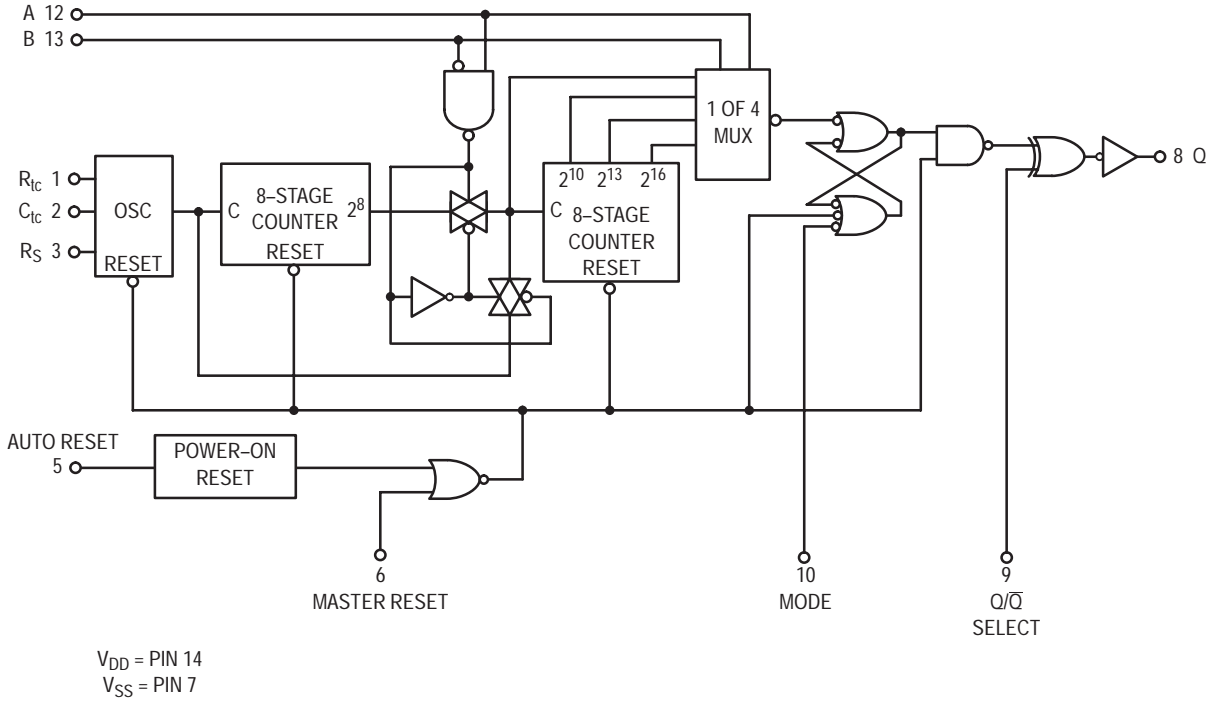
FREQUENCY SELECTION TABLE

A	B	Number of Counter Stages n	Count 2^n
0	0	13	8192
0	1	10	1024
1	0	8	256
1	1	16	65536

TRUTH TABLE

Pin		State	
		0	1
Auto Reset,	5	Auto Reset Operating	Auto Reset Disabled
Master Reset,	6	Timer Operational	Master Reset On
$Q/\overline{Q}$,	9	Output Initially Low After Reset	Output Initially High After Reset
Mode,	10	Single Cycle Mode	Recycle Mode
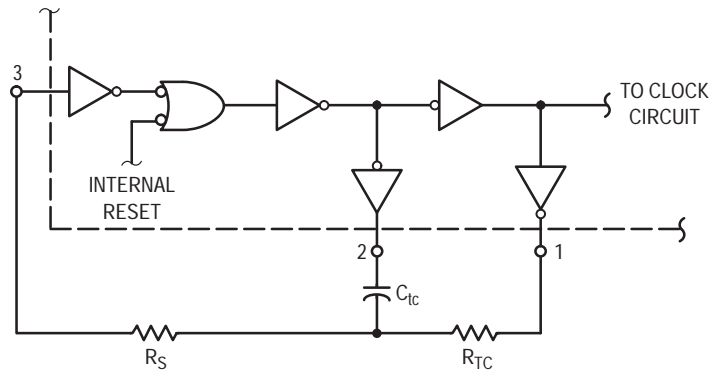
Figure 3. Oscillator Circuit Using RC Configuration

TYPICAL RC OSCILLATOR CHARACTERISTICS
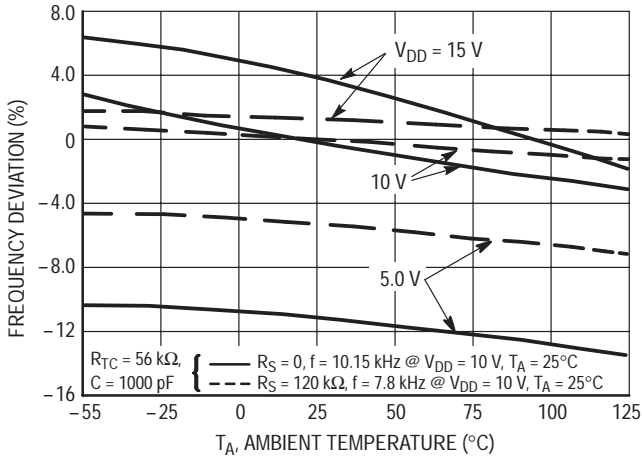
Figure 4. RC Oscillator Stability
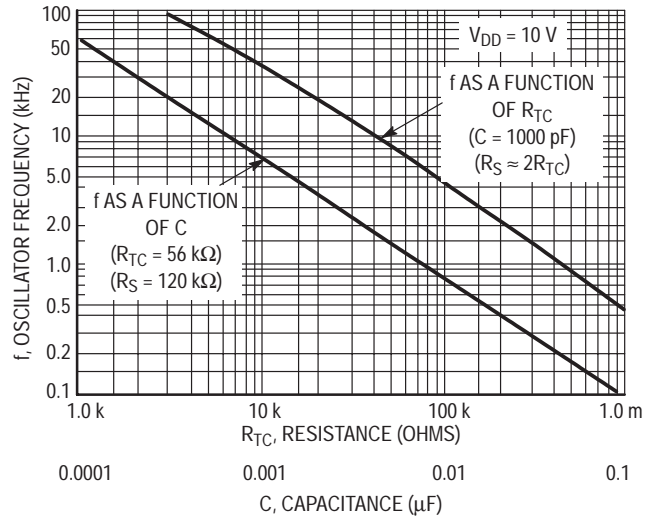
Figure 5. RC Oscillator Frequency as a Function of R_{tc} and C_{tc}

OPERATING CHARACTERISTICS

With Auto Reset pin set to a "0" the counter circuit is initialized by turning on power. Or with power already on, the counter circuit is reset when the Master Reset pin is set to a "1". Both types of reset will result in synchronously resetting all counter stages independent of counter state. Auto Reset pin when set to a "1" provides a low power operation.

The RC oscillator as shown in Figure 3 will oscillate with a frequency determined by the external RC network i.e.,

$$f = \frac{1}{2.3 \ R_{tc}C_{tc}} \qquad \text{if } (1 \text{ kHz} \leq f \leq 100 \text{ kHz})$$

and $\quad R_S \approx 2 \ R_{tc} \qquad$ where $R_S \geq 10 \text{ k}\Omega$

The time select inputs (A and B) provide a two–bit address to output any one of four counter stages (2^8, 2^{10}, 2^{13} and 2^{16}). The 2^n counts as shown in the Frequency Selection Table represents the Q output of the Nth stage of the counter. When A is "1", 2^{16} is selected for both states of B. However,

when B is "0", normal counting is interrupted and the 9th counter stage receives its clock directly from the oscillator (i.e., effectively outputting 2^8).

The Q/$\overline{Q}$ select output control pin provides for a choice of output level. When the counter is in a reset condition and Q/$\overline{Q}$ select pin is set to a "0" the Q output is a "0", correspondingly when Q/$\overline{Q}$ select pin is set to a "1" the Q output is a "1".

When the mode control pin is set to a "1", the selected count is continually transmitted to the output. But, with mode pin "0" and after a reset condition the R_S flip–flop (see Expanded Block Diagram) resets, counting commences, and after 2^{n-1} counts the R_S flip–flop sets which causes the output to change state. Hence, after another 2^{n-1} counts the output will not change. Thus, a Master Reset pulse must be applied or a change in the mode pin level is required to reset the single cycle operation.

DIGITAL TIMER APPLICATION
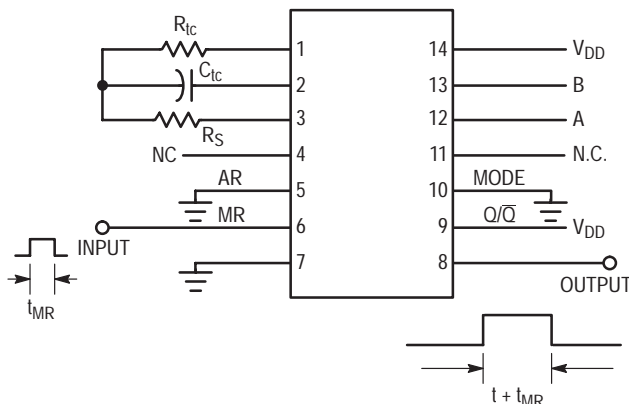
When Master Reset (MR) receives a positive pulse, the internal counters and latch are reset. The Q output goes high and remains high until the selected (via A and B) number of clock pulses are counted, the Q output then goes low and remains low until another input pulse is received.

This "one shot" is fully retriggerable and as accurate as the input frequency. An external clock can be used (pin 3 is the clock input, pins 1 and 2 are outputs) if additional accuracy is needed.

Notice that a setup time equal to the desired pulse width output is required immediately following initial power up, during which time Q output will be high.

PACKAGE DIMENSIONS

### P SUFFIX
PLASTIC DIP PACKAGE
CASE 646–06
ISSUE M
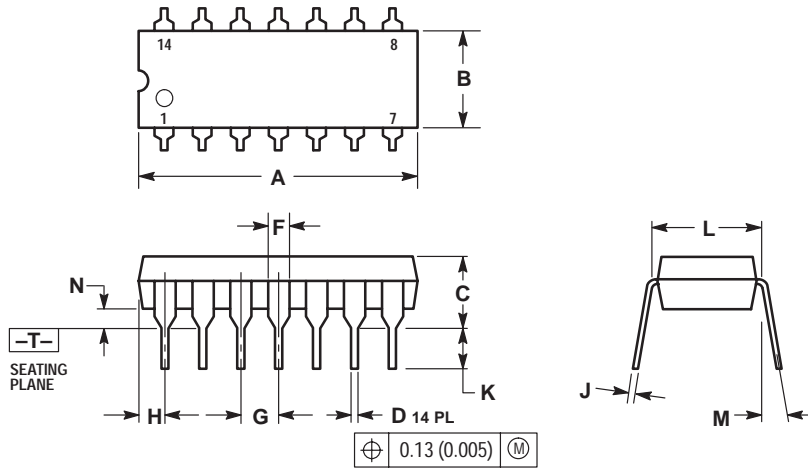
NOTES:
1. DIMENSIONING AND TOLERANCING PER ANSI Y14.5M, 1982.
2. CONTROLLING DIMENSION: INCH.
3. DIMENSION L TO CENTER OF LEADS WHEN FORMED PARALLEL.
4. DIMENSION B DOES NOT INCLUDE MOLD FLASH.
5. ROUNDED CORNERS OPTIONAL.

DIM	INCHES		MILLIMETERS	
	MIN	MAX	MIN	MAX
A	0.715	0.770	18.16	18.80
B	0.240	0.260	6.10	6.60
C	0.145	0.185	3.69	4.69
D	0.015	0.021	0.38	0.53
F	0.040	0.070	1.02	1.78
G	0.100 BSC		2.54 BSC	
H	0.052	0.095	1.32	2.41
J	0.008	0.015	0.20	0.38
K	0.115	0.135	2.92	3.43
L	0.290	0.310	7.37	7.87
M	–––	10°	–––	10°
N	0.015	0.039	0.38	1.01

D SUFFIX
PLASTIC SOIC PACKAGE
CASE 751A–03
ISSUE F
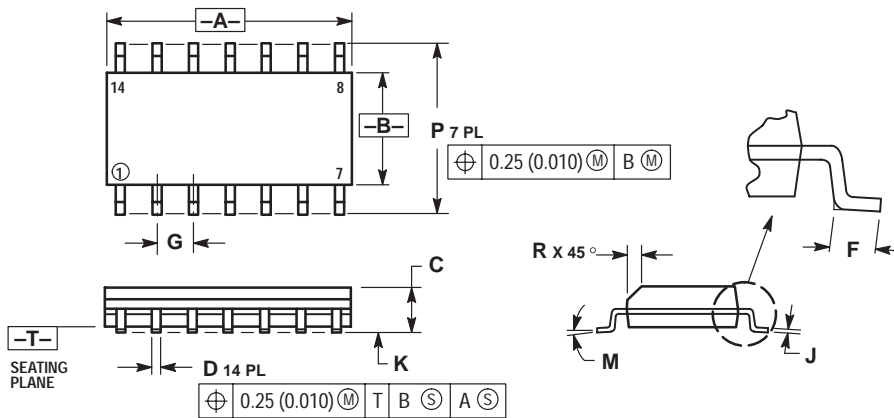
NOTES:
1. DIMENSIONING AND TOLERANCING PER ANSI Y14.5M, 1982.
2. CONTROLLING DIMENSION: MILLIMETER.
3. DIMENSIONS A AND B DO NOT INCLUDE MOLD PROTRUSION.
4. MAXIMUM MOLD PROTRUSION 0.15 (0.006) PER SIDE.
5. DIMENSION D DOES NOT INCLUDE DAMBAR PROTRUSION. ALLOWABLE DAMBAR PROTRUSION SHALL BE 0.127 (0.005) TOTAL IN EXCESS OF THE D DIMENSION AT MAXIMUM MATERIAL CONDITION.

DIM	MILLIMETERS		INCHES	
	MIN	MAX	MIN	MAX
A	8.55	8.75	0.337	0.344
B	3.80	4.00	0.150	0.157
C	1.35	1.75	0.054	0.068
D	0.35	0.49	0.014	0.019
F	0.40	1.25	0.016	0.049
G	1.27 BSC		0.050 BSC	
J	0.19	0.25	0.008	0.009
K	0.10	0.25	0.004	0.009
M	0°	7°	0°	7°
P	5.80	6.20	0.228	0.244
R	0.25	0.50	0.010	0.019

PACKAGE DIMENSIONS

DT SUFFIX
PLASTIC TSSOP PACKAGE
CASE 948G–01
ISSUE O
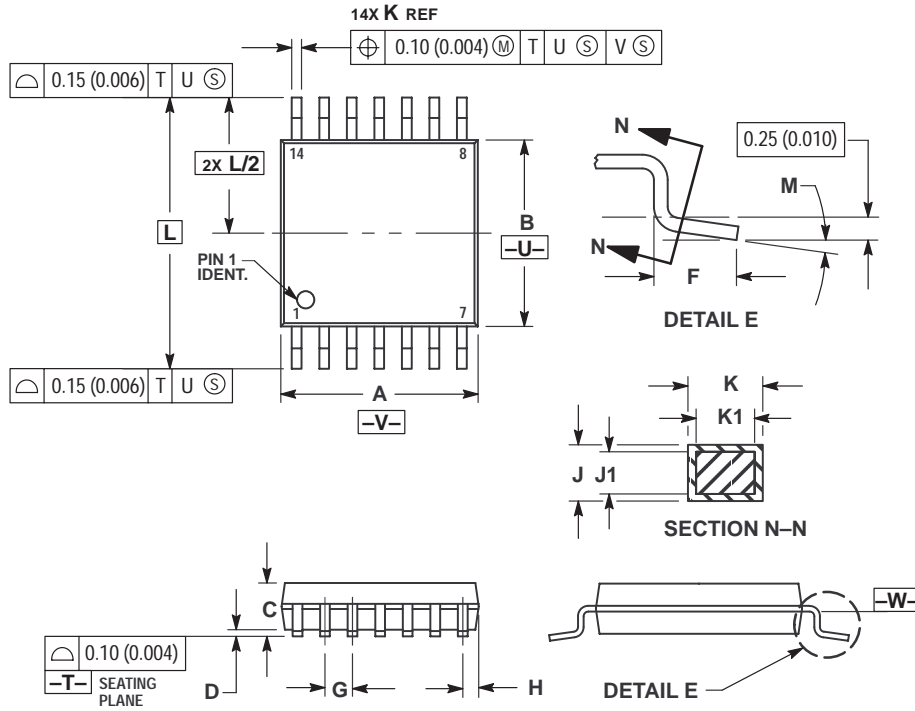
NOTES:
1. DIMENSIONING AND TOLERANCING PER ANSI Y14.5M, 1982.
2. CONTROLLING DIMENSION: MILLIMETER.
3. DIMENSION A DOES NOT INCLUDE MOLD FLASH, PROTRUSIONS OR GATE BURRS. MOLD FLASH OR GATE BURRS SHALL NOT EXCEED 0.15 (0.006) PER SIDE.
4. DIMENSION B DOES NOT INCLUDE INTERLEAD FLASH OR PROTRUSION. INTERLEAD FLASH OR PROTRUSION SHALL NOT EXCEED 0.25 (0.010) PER SIDE.
5. DIMENSION K DOES NOT INCLUDE DAMBAR PROTRUSION. ALLOWABLE DAMBAR PROTRUSION SHALL BE 0.08 (0.003) TOTAL IN EXCESS OF THE K DIMENSION AT MAXIMUM MATERIAL CONDITION.
6. TERMINAL NUMBERS ARE SHOWN FOR REFERENCE ONLY.
7. DIMENSION A AND B ARE TO BE DETERMINED AT DATUM PLANE –W–.

DIM	MILLIMETERS		INCHES	
	MIN	MAX	MIN	MAX
A	4.90	5.10	0.193	0.200
B	4.30	4.50	0.169	0.177
C	–––	1.20	–––	0.047
D	0.05	0.15	0.002	0.006
F	0.50	0.75	0.020	0.030
G	0.65 BSC		0.026 BSC	
H	0.50	0.60	0.020	0.024
J	0.09	0.20	0.004	0.008
J1	0.09	0.16	0.004	0.006
K	0.19	0.30	0.007	0.012
K1	0.19	0.25	0.007	0.010
L	6.40 BSC		0.252 BSC	
M	0 °	8 °	0 °	8 °

MC14541B

PACKAGE DIMENSIONS

F SUFFIX
PLASTIC EIAJ SOIC PACKAGE
CASE 965–01
ISSUE O
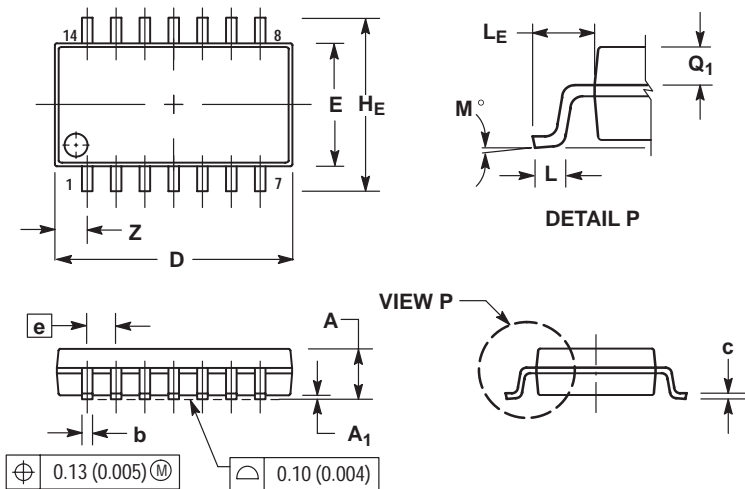
NOTES:
1. DIMENSIONING AND TOLERANCING PER ANSI Y14.5M, 1982.
2. CONTROLLING DIMENSION: MILLIMETER.
3. DIMENSIONS D AND E DO NOT INCLUDE MOLD FLASH OR PROTRUSIONS AND ARE MEASURED AT THE PARTING LINE. MOLD FLASH OR PROTRUSIONS SHALL NOT EXCEED 0.15 (0.006) PER SIDE.
4. TERMINAL NUMBERS ARE SHOWN FOR REFERENCE ONLY.
5. THE LEAD WIDTH DIMENSION (b) DOES NOT INCLUDE DAMBAR PROTRUSION. ALLOWABLE DAMBAR PROTRUSION SHALL BE 0.08 (0.003) TOTAL IN EXCESS OF THE LEAD WIDTH DIMENSION AT MAXIMUM MATERIAL CONDITION. DAMBAR CANNOT BE LOCATED ON THE LOWER RADIUS OR THE FOOT. MINIMUM SPACE BETWEEN PROTRUSIONS AND ADJACENT LEAD TO BE 0.46 (0.018).

DETAIL P

VIEW P

DIM	MILLIMETERS MIN	MILLIMETERS MAX	INCHES MIN	INCHES MAX
A	–––	2.05	–––	0.081
A_1	0.05	0.20	0.002	0.008
b	0.35	0.50	0.014	0.020
c	0.18	0.27	0.007	0.011
D	9.90	10.50	0.390	0.413
E	5.10	5.45	0.201	0.215
e	1.27 BSC		0.050 BSC	
H_E	7.40	8.20	0.291	0.323
0.50	0.50	0.85	0.020	0.033
L_E	1.10	1.50	0.043	0.059
M	0 °	10 °	0 °	10 °
Q_1	0.70	0.90	0.028	0.035
Z	–––	1.42	–––	0.056

MC14541B/D